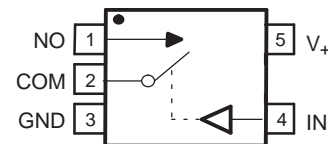
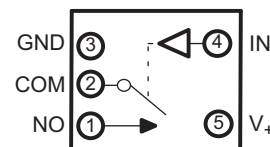


10-Ω SPST ANALOG SWITCH

Check for Samples: [TS5A1066](#)

FEATURES

- Low ON-State Resistance (10 Ω)
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)

**DBV OR DCK PACKAGE
(TOP VIEW)**

**YZP PACKAGE
(BOTTOM VIEW)**


DESCRIPTION/ORDERING INFORMATION

The TS5A1066 is a single-pole single-throw (SPST) analog switch that is designed to operate from 1.65 V to 5.5 V. This device can handle both digital and analog signals, and signals up to V_+ (peak) can be transmitted in either direction.

Table 1. SUMMARY OF CHARACTERISTICS

Configuration	Single-Pole, Single-Throw Demultiplexer (1 × SPST)
Number of channels	1
ON-state resistance (r_{on})	7.5 Ω
ON-state resistance flatness ($r_{on(flat)}$)	2.5 Ω
Turn-on/turn-off time (t_{ON}/t_{OFF})	9.5 ns/2 ns
Charge injection (Q_C)	1 pC
Bandwidth (BW)	400 MHz
OFF isolation (O_{ISO})	−68 dB at 10 MHz
Total harmonic distortion (THD)	0.14%
Leakage current ($I_{COM(OFF)}$)	±0.1 μA
Power-supply current (I_+)	0.05 μA
Package options	5-pin DSBGA, SOT-23, or SC-70



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

Table 2. ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽²⁾
–40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Tape and reel	TS5A1066YZPR	JD_
	SOT (SOT-23) – DBV	Tape and reel	TS5A1066DBVR	JAD_
	SOT (SC-70) – DCK	Tape and reel	TS5A1066DCKR	JD_

- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.
YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

FUNCTION TABLE

IN	NO TO COM, COM TO NO
L	OFF
H	ON

Absolute Minimum and Maximum Rating^{(1) (2)}

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V ₊	Supply voltage range ⁽³⁾	–0.5	6.5	V
V _{NO} V _{COM}	Analog voltage range ^{(3) (4) (5)}	–0.5	V ₊ + 0.5	V
I _K	Analog port diode current V _{NO} , V _{COM} < 0 or V _{NO} , V _{COM} > V ₊	–50	50	mA
I _{NO} I _{COM}	On-state switch current V _{NO} , V _{COM} = 0 to V ₊	–50	50	mA
V _I	Digital input voltage range ^{(3) (4)}	–0.5	6.5	V
I _{IK}	Digital input clamp current V _I < 0	–50		mA
I ₊ I _{GND}	Continuous current through each V ₊ or GND	–100	100	mA
θ _{JA}	Package thermal impedance ⁽⁶⁾ DBV package		206	°C/W
	DCK package		252	
	YZP package		132	
T _{stg}	Storage temperature range	–65	150	°C

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.
- (3) All voltages are with respect to ground, unless otherwise specified.
- (4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- (5) This value is limited to 5.5 V maximum.
- (6) The package thermal impedance is calculated in accordance with JESD 51-7.

Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_+ = 4.5 \text{ V to } 5.5 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch								
Analog signal range	$V_{\text{COM}}, V_{\text{NO}}$				0		V_+	V
ON-state resistance	r_{on}	$0 \leq V_{\text{NO}} \leq V_+$, $I_{\text{COM}} = -30 \text{ mA}$, Switch ON, See Figure 13	25°C Full	4.5 V	7.5		10 12	Ω
ON-state resistance flatness	$r_{\text{on(flat)}}$	$0 \leq V_{\text{NO}} \leq V_+$, $I_{\text{COM}} = -30 \text{ mA}$, Switch ON, See Figure 13	25°C Full	4.5 V	2.5		5 6	Ω
NO OFF leakage current	$I_{\text{NO(OFF)}}$	$V_{\text{NO}} = 1 \text{ V}$, $V_{\text{COM}} = 4.5 \text{ V}$, or $V_{\text{NO}} = 4.5 \text{ V}$, $V_{\text{COM}} = 1 \text{ V}$, Switch OFF, See Figure 14	25°C Full	5.5 V	-0.2 -2	0.1	0.2 2	μA
COM OFF leakage current	$I_{\text{COM(OFF)}}$	$V_{\text{COM}} = 1 \text{ V}$, $V_{\text{NO}} = 4.5 \text{ V}$, or $V_{\text{COM}} = 4.5 \text{ V}$, $V_{\text{NO}} = 1 \text{ V}$, Switch OFF, See Figure 14	25°C Full	5.5 V	-0.1 -0.2	0.05	0.1 0.2	μA
NO ON leakage current	$I_{\text{NO(ON)}}$	$V_{\text{NO}} = 1 \text{ V}$, $V_{\text{COM}} = \text{Open}$, or $V_{\text{NO}} = 4.5 \text{ V}$, $V_{\text{COM}} = \text{Open}$, Switch ON, See Figure 15	25°C Full	5.5 V	-0.2 -2	0.1	0.2 2	μA
COM ON leakage current	$I_{\text{COM(ON)}}$	$V_{\text{COM}} = 1 \text{ V}$, $V_{\text{NO}} = \text{Open}$, or $V_{\text{COM}} = 4.5 \text{ V}$, $V_{\text{NO}} = \text{Open}$, Switch ON, See Figure 15	25°C Full	5.5 V	-0.1 -0.2	0.05	0.1 0.2	μA
Digital Control Input (IN)								
Input logic high	V_{IH}		Full		$V_+ \times 0.7$		5.5	V
Input logic low	V_{IL}		Full		0		$V_+ \times 0.3$	V
Input leakage current	$I_{\text{IH}}, I_{\text{IL}}$	$V_{\text{I}} = 5.5 \text{ V or } 0$	25°C Full	5.5 V	-0.1 -1	0.05	0.1 1	μA

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

Electrical Characteristics for 5-V Supply⁽¹⁾ (continued) $V_+ = 4.5\text{ V to }5.5\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T _A	V ₊	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time	t _{ON}	V _{COM} = 3 V, R _L = 300 Ω,	C _L = 35 pF, See Figure 17	25°C	5 V	3.5	4.8	5.5	ns
				Full	4.5 V to 5.5 V	3.5		7.5	
Turn-off time	t _{OFF}	V _{COM} = 3 V, R _L = 300 Ω,	C _L = 35 pF, See Figure 17	25°C	5 V	2	3	4.5	ns
				Full	4.5 V to 5.5 V	2		5.5	
Charge injection	Q _C	V _{GEN} = 0, C _L = 0.1 nF,	See Figure 20	25°C	5 V	1			pC
NO OFF capacitance	C _{NO(OFF)}	V _{NO} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	5 V	6.8			pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	5 V	6.8			pF
NO ON capacitance	C _{NO(ON)}	V _{NO} = V ₊ or GND, Switch ON,	See Figure 16	25°C	5 V	14			pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	5 V	14			pF
Digital input capacitance	C _I	V _I = V ₊ or GND,	See Figure 16	25°C	5 V	2.2			pF
Bandwidth	BW	R _L = 50 Ω, Switch ON,	See Figure 18	25°C	5 V	400			MHz
OFF isolation	O _{ISO}	R _L = 50 Ω, f = 10 MHz,	Switch OFF, See Figure 19	25°C	5 V	−68			dB
Total harmonic distortion	THD	R _L = 600 Ω, C _L = 50 pF,	f = 20 Hz to 20 kHz, See Figure 21	25°C	5 V	0.14			%
Supply									
Positive supply current	I ₊	V _I = V ₊ or GND,	Switch ON or OFF	25°C	5.5 V	0.05		1	μA
				Full				5	

Electrical Characteristics for 3.3-V Supply⁽¹⁾

 $V_+ = 3\text{ V to }3.6\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch								
Analog signal range	V_{COM}, V_{NO}				0		V_+	V
ON-state resistance	r_{on}	$0 \leq V_{NO} \leq V_+$, $I_{COM} = -24\text{ mA}$, Switch ON, See Figure 13	25°C Full	3 V		11.5	14 17	Ω
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NO} \leq V_+$, $I_{COM} = -24\text{ mA}$, Switch ON, See Figure 13	25°C Full	3 V		5	10 12	Ω
NO OFF leakage current	$I_{NO(OFF)}$	$V_{NO} = 1\text{ V}$, $V_{COM} = 3\text{ V}$, or $V_{NO} = 3\text{ V}$, $V_{COM} = 1\text{ V}$, Switch OFF, See Figure 14	25°C Full	3.6 V	-0.2 -2	0.1	0.2 2	μA
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 1\text{ V}$, $V_{NO} = 3\text{ V}$, or $V_{COM} = 3\text{ V}$, $V_{NO} = 1\text{ V}$, Switch OFF, See Figure 14	25°C Full	3.6 V	-0.1 -0.2	0.05	0.1 0.2	μA
NO ON leakage current	$I_{NO(ON)}$	$V_{NO} = 1\text{ V}$, $V_{COM} = \text{Open}$, or $V_{NO} = 3\text{ V}$, $V_{COM} = \text{Open}$, Switch ON, See Figure 15	25°C Full	3.6 V	-0.2 -2	0.1	0.2 2	μA
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 1\text{ V}$, $V_{NO} = \text{Open}$, or $V_{COM} = 3\text{ V}$, $V_{NO} = \text{Open}$, Switch ON, See Figure 15	25°C Full	3.6 V	-0.1 -0.2	0.05	0.1 0.2	μA
Digital Control Input (IN)								
Input logic high	V_{IH}		Full		$V_+ \times 0.7$		5.5	V
Input logic low	V_{IL}		Full		0		$V_+ \times 0.3$	V
Input leakage current	I_{IH}, I_{IL}	$V_I = 5.5\text{ V or }0$	25°C Full	3.6 V	-0.1 -1	0.05	0.1 1	μA

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

Electrical Characteristics for 3.3-V Supply⁽¹⁾ (continued)
 $V_+ = 3\text{ V to }3.6\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	T_A	V_+	MIN	TYP	MAX	UNIT
Dynamic								
Turn-on time	t_{ON}	$V_{COM} = 2\text{ V}$, $R_L = 300\ \Omega$, $C_L = 35\text{ pF}$, See Figure 17	25°C	3.3 V	4.5	5.5	8	ns
			Full	3 V to 3.6 V	4.5		8.5	
Turn-off time	t_{OFF}	$V_{COM} = 2\text{ V}$, $R_L = 300\ \Omega$, $C_L = 35\text{ pF}$, See Figure 17	25°C	3.3 V	2	3	4.5	ns
			Full	3 V to 3.6 V	2		5.5	
Charge injection	Q_C	$V_{GEN} = 0$, $C_L = 0.1\text{ nF}$, See Figure 20	25°C	3.3 V		1		pC
NO OFF capacitance	$C_{NO(OFF)}$	$V_{NO} = V_+$ or GND, Switch OFF, See Figure 16	25°C	3.3 V		6.8		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_+$ or GND, Switch OFF, See Figure 16	25°C	3.3 V		6.8		pF
NO ON capacitance	$C_{NO(ON)}$	$V_{NO} = V_+$ or GND, Switch ON, See Figure 16	25°C	3.3 V		14		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_+$ or GND, Switch ON, See Figure 16	25°C	3.3 V		14		pF
Digital input capacitance	C_I	$V_I = V_+$ or GND, See Figure 16	25°C	3.3 V		2.2		pF
Bandwidth	BW	$R_L = 50\ \Omega$, Switch ON, See Figure 18	25°C	3.3 V		400		MHz
OFF isolation	O_{ISO}	$R_L = 50\ \Omega$, $f = 10\text{ MHz}$, Switch OFF, See Figure 19	25°C	3.3 V		-68		dB
Total harmonic distortion	THD	$R_L = 600\ \Omega$, $C_L = 50\text{ pF}$, $f = 20\text{ Hz to }20\text{ kHz}$, See Figure 21	25°C	3.3 V		0.2		%
Supply								
Positive supply current	I_+	$V_I = V_+$ or GND, Switch ON or OFF	25°C	3.6 V		0.05	1	μA
			Full				5	

Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $V_+ = 2.3 \text{ V to } 2.7 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	T_A	V_+	MIN	TYP	MAX	UNIT
Analog Switch								
Analog signal range	V_{COM}, V_{NO}				0		V_+	V
ON-state resistance	r_{on}	$0 \leq V_{NO} \leq V_+$, $I_{COM} = -8 \text{ mA}$, Switch ON, See Figure 13	25°C Full	2.3 V		20	24 27	Ω
ON-state resistance flatness	$r_{on(flat)}$	$0 \leq V_{NO} \leq V_+$, $I_{COM} = -8 \text{ mA}$, Switch ON, See Figure 13	25°C Full	2.3 V		7.5	15 20	Ω
NO OFF leakage current	$I_{NO(OFF)}$	$V_{NO} = 0.5 \text{ V}$, $V_{COM} = 2.2 \text{ V}$, or $V_{NO} = 2.2 \text{ V}$, $V_{COM} = 0.5 \text{ V}$, Switch OFF, See Figure 14	25°C Full	2.7 V	-0.2 -2	0.1	0.2 2	μA
COM OFF leakage current	$I_{COM(OFF)}$	$V_{COM} = 0.5 \text{ V}$, $V_{NO} = 2.2 \text{ V}$, or $V_{COM} = 2.2 \text{ V}$, $V_{NO} = 0.5 \text{ V}$, Switch OFF, See Figure 14	25°C Full	2.7 V	-0.1 -0.2	0.05	0.1 0.2	μA
NO ON leakage current	$I_{NO(ON)}$	$V_{NO} = 0.5 \text{ V}$, $V_{COM} = \text{Open}$, or $V_{NO} = 2.2 \text{ V}$, $V_{COM} = \text{Open}$, Switch ON, See Figure 15	25°C Full	2.7 V	-0.2 -2	0.1	0.2 2	μA
COM ON leakage current	$I_{COM(ON)}$	$V_{COM} = 0.5 \text{ V}$, $V_{NO} = \text{Open}$, or $V_{COM} = 2.2 \text{ V}$, $V_{NO} = \text{Open}$, Switch ON, See Figure 15	25°C Full	2.7 V	-0.1 -0.2	0.05	0.1 0.2	μA
Digital Control Input (IN)								
Input logic high	V_{IH}		Full		$V_+ \times 0.7$		5.5	V
Input logic low	V_{IL}		Full		0		$V_+ \times 0.3$	V
Input leakage current	I_{IH}, I_{IL}	$V_I = 5.5 \text{ V or } 0$	25°C Full	2.7 V	-0.1 -1	0.05	0.1 1	μA

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

Electrical Characteristics for 2.5-V Supply⁽¹⁾ (continued)
 $V_+ = 2.3 \text{ V to } 2.7 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS	T_A	V_+	MIN	TYP	MAX	UNIT
Dynamic								
Turn-on time	t_{ON}	$V_{COM} = 1.5 \text{ V}$, $R_L = 300 \Omega$, $C_L = 35 \text{ pF}$, See Figure 17	25°C	2.5 V	4.5	5.5	8	ns
			Full	2.3 V to 2.7 V	4.5		8.5	
Turn-off time	t_{OFF}	$V_{COM} = 1.5 \text{ V}$, $R_L = 300 \Omega$, $C_L = 35 \text{ pF}$, See Figure 17	25°C	2.5 V	1.5	2.5	4	ns
			Full	2.3 V to 2.7 V	1.5		5.5	
Charge injection	Q_C	$V_{GEN} = 0$, $C_L = 0.1 \text{ nF}$, See Figure 20	25°C	2.5 V		1		pC
NO OFF capacitance	$C_{NO(OFF)}$	$V_{NO} = V_+$ or GND, Switch OFF, See Figure 16	25°C	2.5 V		6.8		pF
COM OFF capacitance	$C_{COM(OFF)}$	$V_{COM} = V_+$ or GND, Switch OFF, See Figure 16	25°C	2.5 V		6.8		pF
NO ON capacitance	$C_{NO(ON)}$	$V_{NO} = V_+$ or GND, Switch ON, See Figure 16	25°C	2.5 V		14		pF
COM ON capacitance	$C_{COM(ON)}$	$V_{COM} = V_+$ or GND, Switch ON, See Figure 16	25°C	2.5 V		14		pF
Digital input capacitance	C_I	$V_I = V_+$ or GND, See Figure 16	25°C	2.5 V		2.2		pF
Bandwidth	BW	$R_L = 50 \Omega$, Switch ON, See Figure 18	25°C	2.5 V		400		MHz
OFF isolation	O_{ISO}	$R_L = 50 \Omega$, $f = 10 \text{ MHz}$, Switch OFF, See Figure 19	25°C	2.5 V		-68		dB
Total harmonic distortion	THD	$R_L = 600 \Omega$, $C_L = 50 \text{ pF}$, $f = 20 \text{ Hz to } 20 \text{ kHz}$, See Figure 21	25°C	2.5 V		0.32		%
Supply								
Positive supply current	I_+	$V_I = V_+$ or GND, Switch ON or OFF	25°C	2.7 V		0.05	1	μA
			Full				5	

Electrical Characteristics for 1.8-V Supply⁽¹⁾

 $V_+ = 1.65 \text{ V to } 1.95 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T _A	V ₊	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO}					0		V ₊	V
ON-state resistance	r _{on}	0 ≤ V _{NO} ≤ V ₊ , I _{COM} = −4 mA,	Switch ON, See Figure 13	25°C	1.65 V	74.5		80	Ω
				Full				100	
ON-state resistance flatness	r _{on(flat)}	0 ≤ V _{NO} ≤ V ₊ , I _{COM} = −4 mA,	Switch ON, See Figure 13	25°C	1.65 V	64.5		70	Ω
				Full				90	
NO OFF leakage current	I _{NO(OFF)}	V _{NO} = 0.3 V, V _{COM} = 1.65 V, or V _{NO} = 1.65 V, V _{COM} = 0.3 V,	Switch OFF, See Figure 14	25°C	1.95 V	−0.2	0.1	0.2	μA
				Full		−2		2	
COM OFF leakage current	I _{COM(OFF)}	V _{COM} = 0.3 V, V _{NO} = 1.65 V, or V _{COM} = 1.65 V, V _{NO} = 0.3 V,	Switch OFF, See Figure 14	25°C	1.95 V	−0.1	0.05	0.1	μA
				Full		−0.2		0.2	
NO ON leakage current	I _{NO(ON)}	V _{NO} = 0.3 V, V _{COM} = Open, or V _{NO} = 1.65 V, V _{COM} = Open,	Switch ON, See Figure 15	25°C	1.95 V	−0.2	0.1	0.2	μA
				Full		−2		2	
COM ON leakage current	I _{COM(ON)}	V _{COM} = 0.3 V, V _{NO} = Open, or V _{COM} = 1.65 V, V _{NO} = Open,	Switch ON, See Figure 15	25°C	1.95 V	−0.1	0.05	0.1	μA
				Full		−0.2		0.2	
Digital Control Input (IN)									
Input logic high	V _{IH}			Full		V ₊ × 0.65		5.5	V
Input logic low	V _{IL}			Full		0		V ₊ × 0.35	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C	1.95 V	−0.1	0.05	0.1	μA
				Full		−1		1	

(1) The algebraic convention is used in this data sheet; the most negative value is shown in the minimum column.

Electrical Characteristics for 1.8-V Supply⁽¹⁾ (continued)
 $V_+ = 1.65 \text{ V to } 1.95 \text{ V}$, $T_A = -40^\circ\text{C to } 85^\circ\text{C}$ (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIONS		T _A	V ₊	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time	t _{ON}	V _{COM} = 1.3 V, R _L = 300 Ω,	C _L = 35 pF, See Figure 17	25°C	1.8 V	9.5	10	12	ns
				Full	1.65 V to 1.95 V	8.5		13	
Turn-off time	t _{OFF}	V _{COM} = 1.3 V, R _L = 300 Ω,	C _L = 35 pF, See Figure 17	25°C	1.8 V	1.5	2	4	ns
				Full	1.65 V to 1.95 V	1.5		5.5	
Charge injection	Q _C	V _{GEN} = 0, C _L = 0.1 nF,	See Figure 20	25°C	1.8 V		1		pC
NO OFF capacitance	C _{NO(OFF)}	V _{NO} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		6.8		pF
COM OFF capacitance	C _{COM(OFF)}	V _{COM} = V ₊ or GND, Switch OFF,	See Figure 16	25°C	1.8 V		6.8		pF
NO ON capacitance	C _{NO(ON)}	V _{NO} = V ₊ or GND, Switch ON,	See Figure 16	25°C	1.8 V		14		pF
COM ON capacitance	C _{COM(ON)}	V _{COM} = V ₊ or GND, Switch ON,	See Figure 16	25°C	1.8 V		14		pF
Digital input capacitance	C _I	V _I = V ₊ or GND,	See Figure 16	25°C	1.8 V		2.2		pF
Bandwidth	BW	R _L = 50 Ω, Switch ON,	See Figure 18	25°C	1.8 V		400		MHz
OFF isolation	O _{ISO}	R _L = 50 Ω, f = 10 MHz,	Switch OFF, See Figure 19	25°C	1.8 V		−68		dB
Total harmonic distortion	THD	R _L = 600 Ω, C _L = 50 pF,	f = 20 Hz to 20 kHz, See Figure 21	25°C	1.8 V		0.32		%
Supply									
Positive supply current	I ₊	V _I = V ₊ or GND,	Switch ON or OFF	25°C	1.95 V	0.05		1	μA
				Full				5	

TYPICAL PERFORMANCE

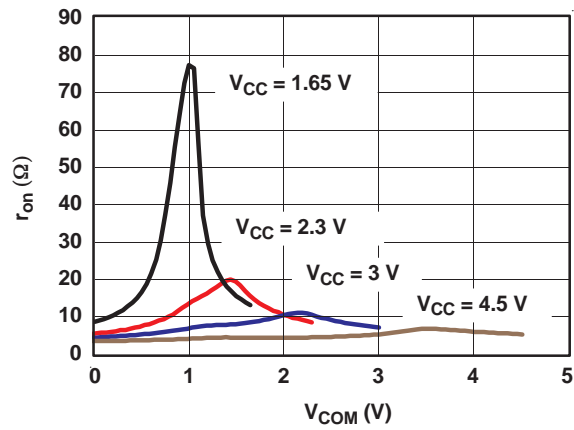


Figure 1. r_{on} vs V_{COM}

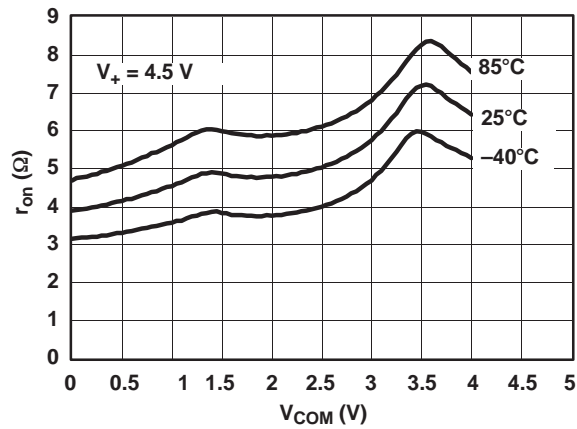


Figure 2. r_{on} vs V_{COM} ($V_+ = 3$ V)

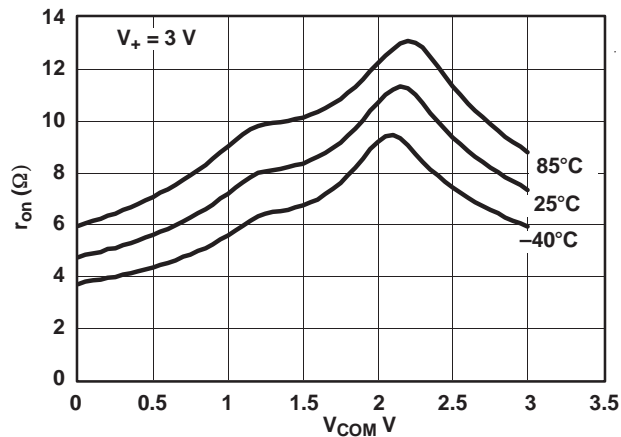
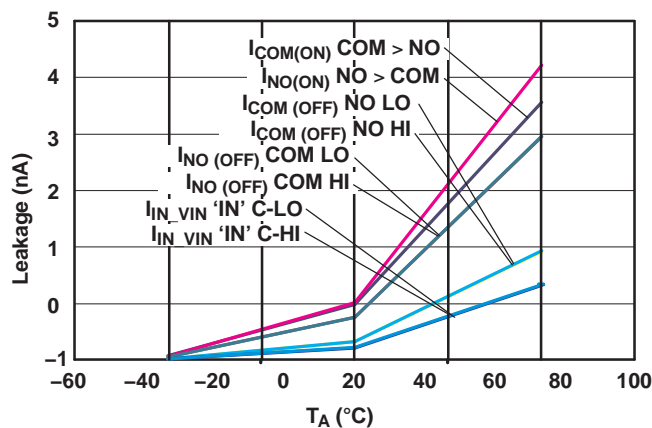
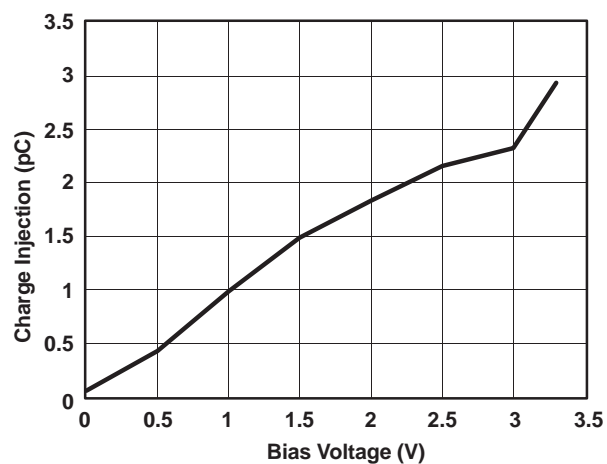
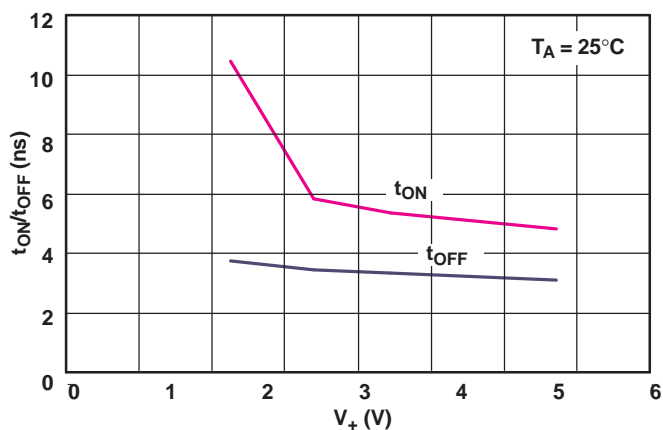


Figure 3. r_{on} vs V_{COM} ($V_+ = 5$ V)

TYPICAL PERFORMANCE

Figure 4. Leakage Current vs Temperature ($V_+ = 5.5\text{ V}$)Figure 5. Charge Injection (Q_C) vs Bias VoltageFigure 6. t_{ON} and t_{OFF} vs Supply Voltage

TYPICAL PERFORMANCE

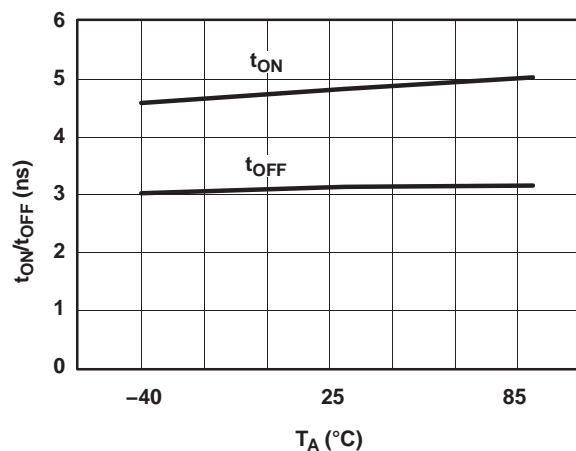


Figure 7. t_{ON} and t_{OFF} vs Temperature ($V_+ = 5$ V)

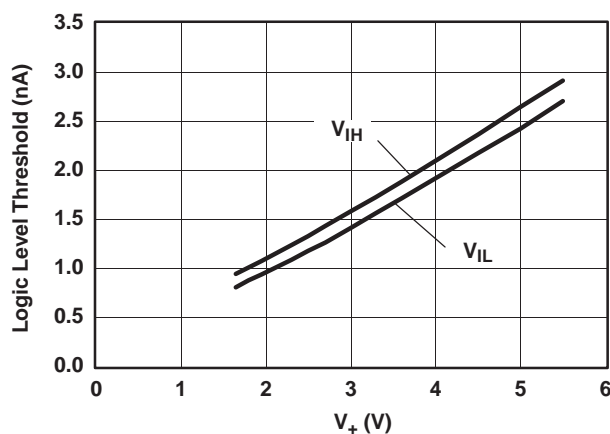


Figure 8. Logic-Level Threshold vs V_+

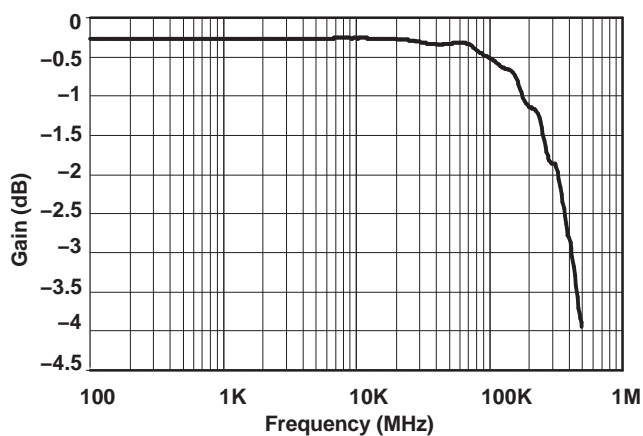


Figure 9. Bandwidth ($V_+ = 5$ V)

TYPICAL PERFORMANCE

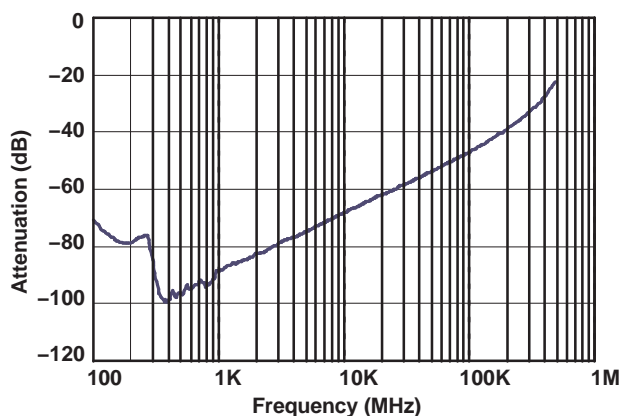
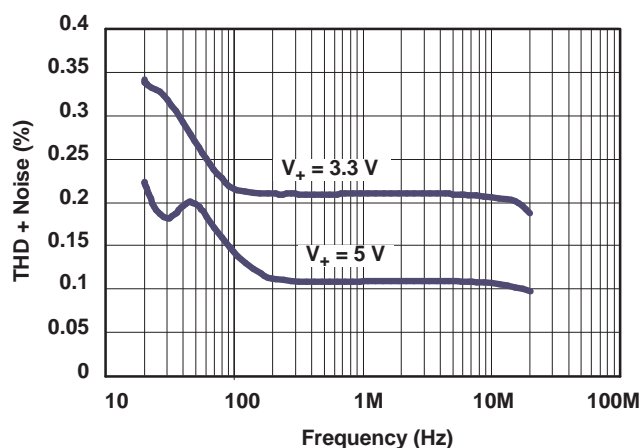
Figure 10. OFF Isolation ($V_+ = 5\text{ V}$)

Figure 11. Total Harmonic Distortion vs Frequency

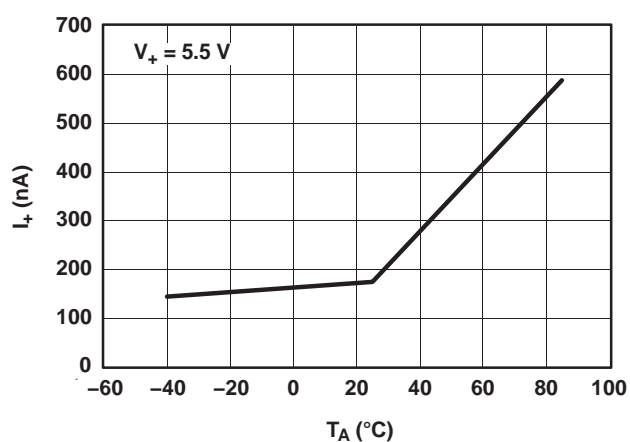
Figure 12. Power-Supply Current vs Temperature ($V_+ = 5\text{ V}$)

Table 3. PIN DESCRIPTION

PIN	NAME	DESCRIPTION
1	NO	Normally open
2	COM	Common
3	GND	Digital ground
4	IN	Digital control to connect COM to NO
5	V ₊	Power supply

Table 4. PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V _{COM}	Voltage at COM
V _{NO}	Voltage at NO
r _{on}	Resistance between COM and NO ports when the channel is ON
r _{on(flat)}	Difference between the maximum and minimum value of r _{on} in a channel over the specified range of conditions
I _{NO(OFF)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state
I _{NO(ON)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open
I _{COM(OFF)}	Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the OFF state
I _{COM(ON)}	Leakage current measured at the COM port, with the corresponding channel (COM to NO) in the ON state and the output (NO) open
V _{IH}	Minimum input voltage for logic high for the control input (IN)
V _{IL}	Maximum input voltage for logic low for the control input (IN)
V _I	Voltage at the control input (IN)
I _{IH} , I _{IL}	Leakage current measured at the control input (IN)
t _{ON}	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning ON.
t _{OFF}	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NO) signal when the switch is turning OFF.
Q _C	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NO or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, Q _C = C _L × ΔV _{COM} , C _L is the load capacitance and ΔV _{COM} is the change in analog output voltage.
C _{NO(OFF)}	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
C _{NO(ON)}	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
C _{COM(OFF)}	Capacitance at the COM port when the corresponding channel (COM to NO) is OFF
C _{COM(ON)}	Capacitance at the COM port when the corresponding channel (COM to NO) is ON
C _I	Capacitance of IN
O _{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NO to COM) in the OFF state.
BW	Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion is defined as the ratio of the root mean square (RMS) value of the second, third, and higher harmonics to the magnitude of fundamental harmonic.
I ₊	Static power-supply current with the control (IN) pin at V ₊ or GND
ΔI ₊	This is the increase in I ₊ for each control (IN) input that is at the specified voltage, rather than at V ₊ or GND.

PARAMETER MEASUREMENT INFORMATION

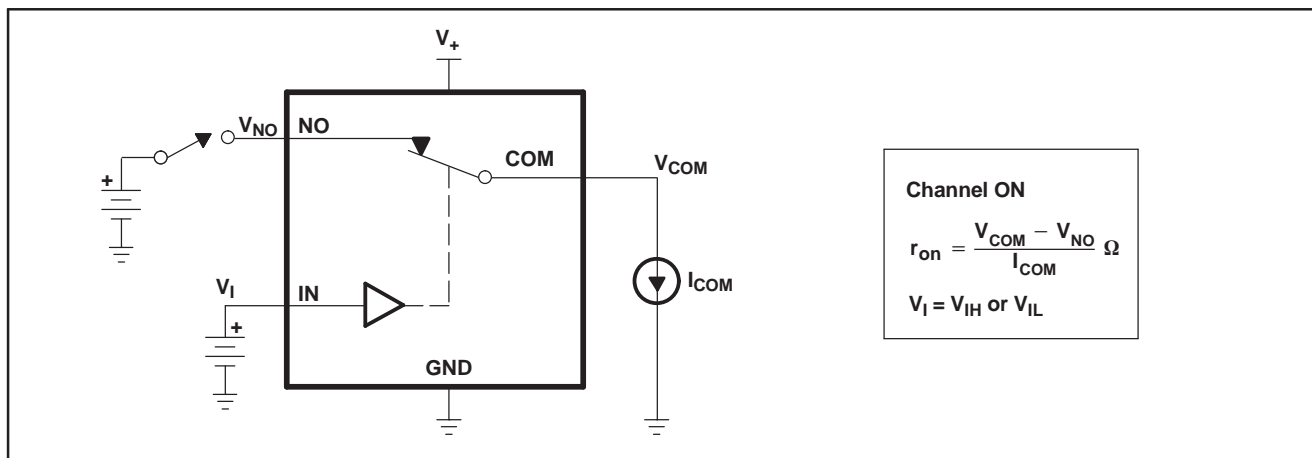


Figure 13. ON-State Resistance (r_{on})

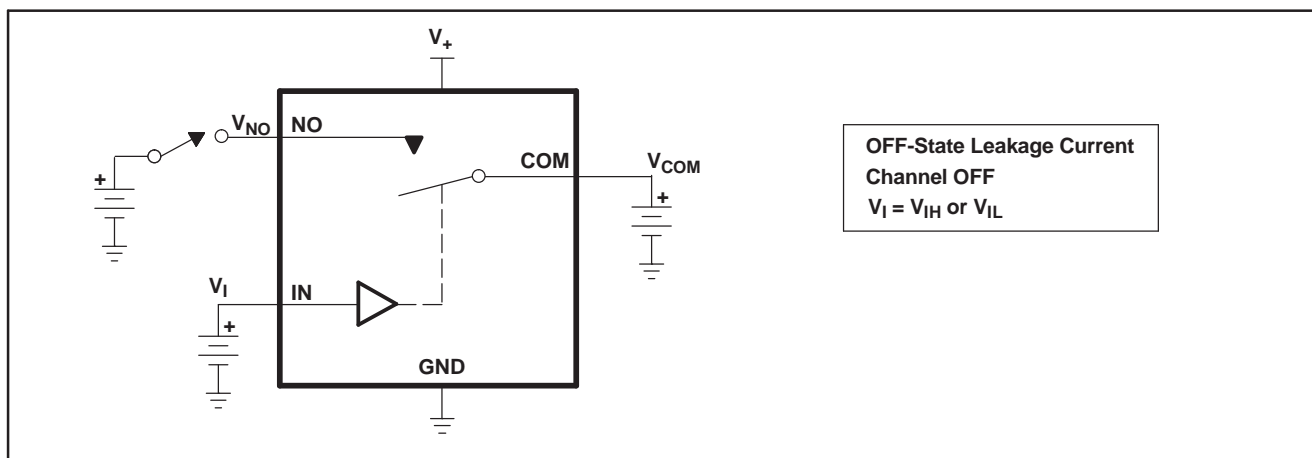


Figure 14. OFF-State Leakage Current ($I_{COM(OFF)}$, $I_{NO(OFF)}$)

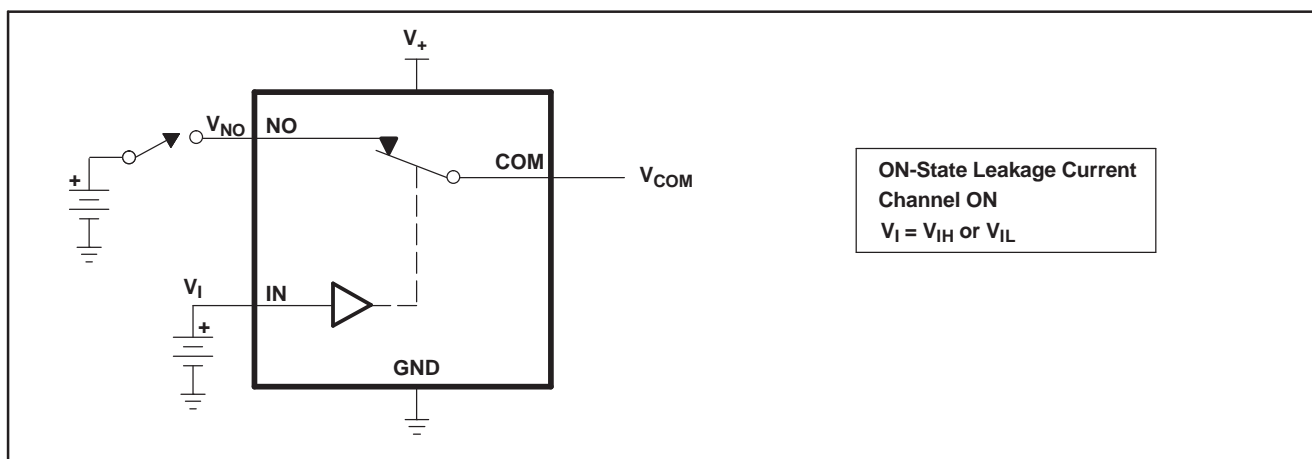


Figure 15. ON-State Leakage Current ($I_{COM(ON)}$, $I_{NO(ON)}$)

PARAMETER MEASUREMENT INFORMATION (continued)

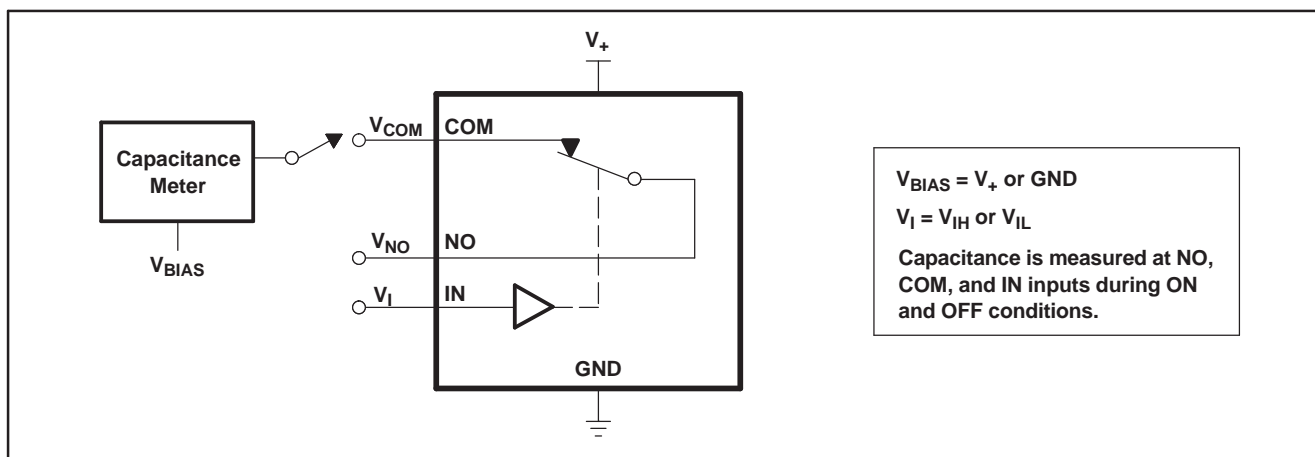
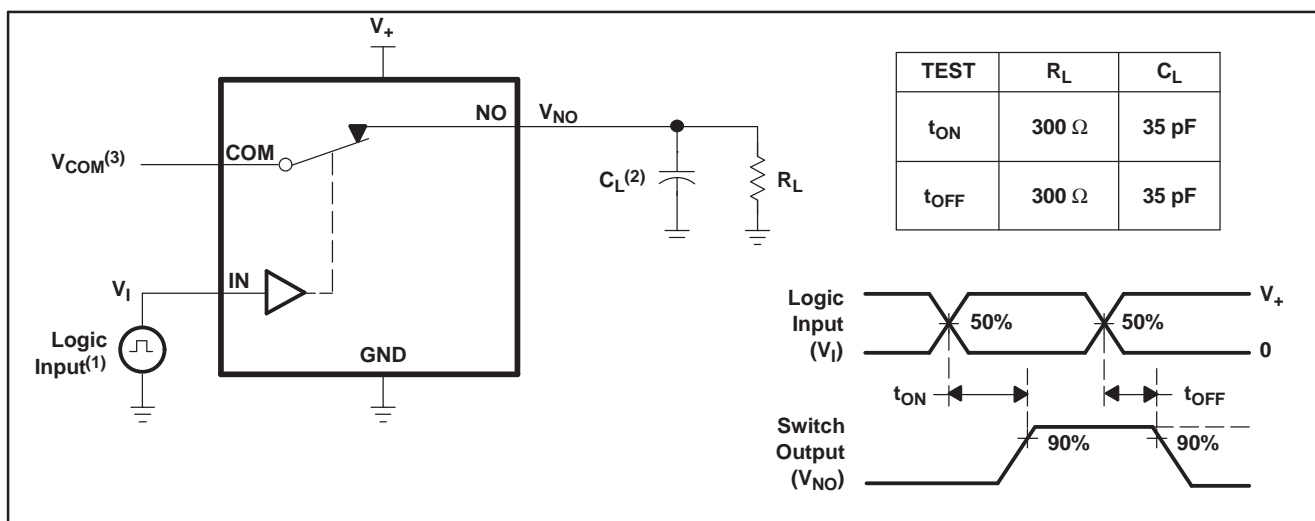
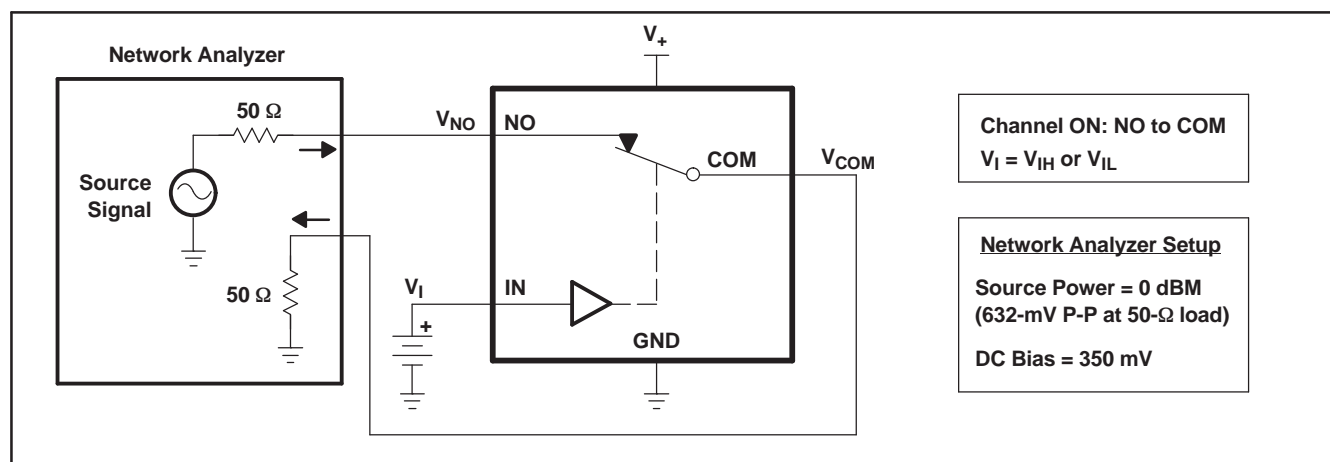
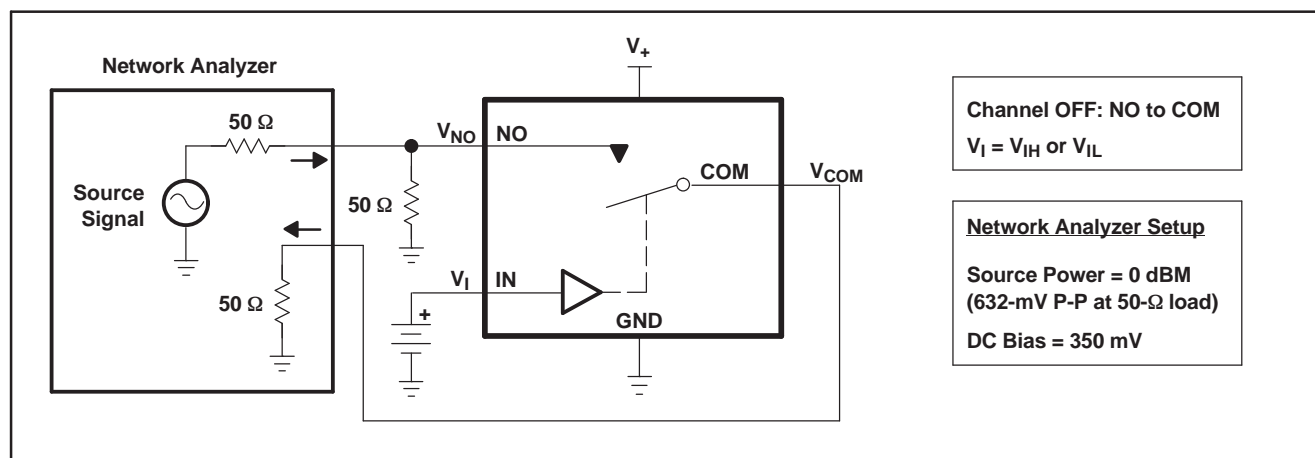


Figure 16. Capacitance (C_I , $C_{COM(OFF)}$, $C_{COM(ON)}$, $C_{NO(OFF)}$, $C_{NO(ON)}$)

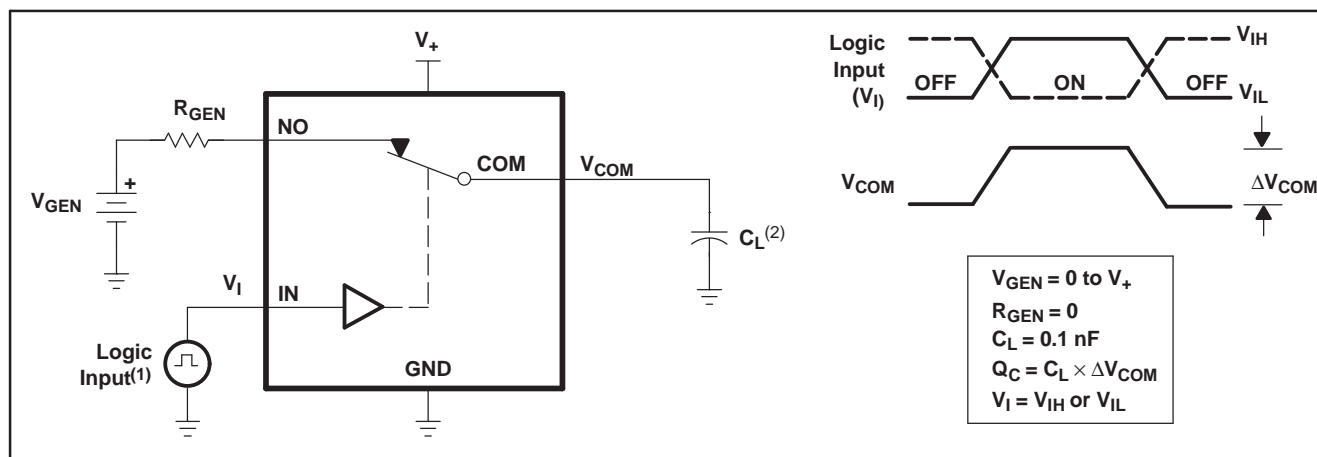


- (1) All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r < 5 \text{ ns}$, $t_f < 5 \text{ ns}$.
 (2) C_L includes probe and jig capacitance.
 (3) See Electrical Characteristics for V_{COM} .

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

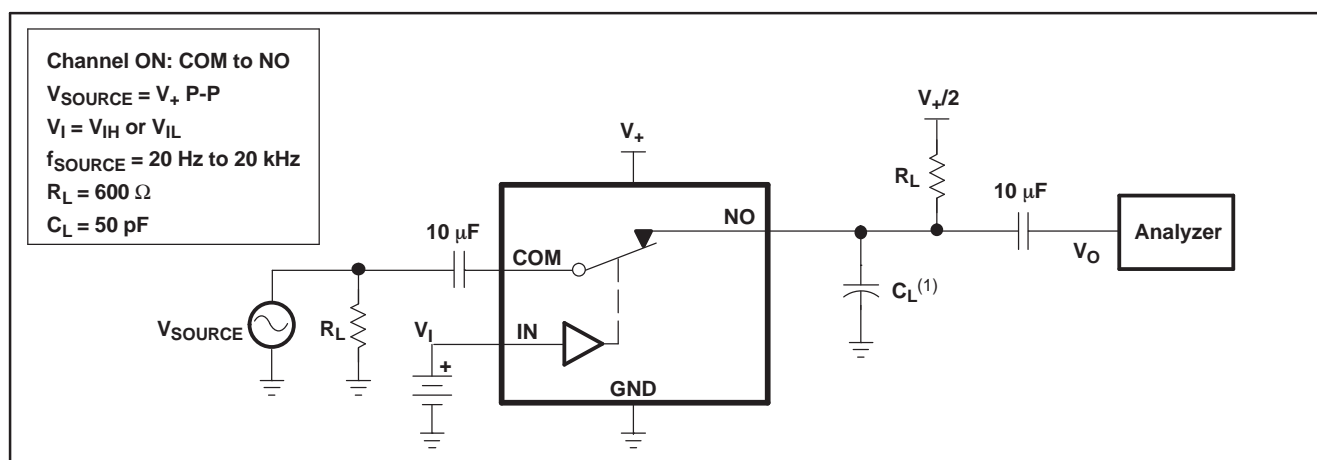
PARAMETER MEASUREMENT INFORMATION (continued)**Figure 18. Bandwidth (BW)****Figure 19. OFF Isolation (O_{ISO})**

PARAMETER MEASUREMENT INFORMATION (continued)



- (1) All input pulses are supplied by generators having the following characteristics: $PRR \leq 10$ MHz, $Z_O = 50 \Omega$, $t_r < 5$ ns, $t_f < 5$ ns.
(2) C_L includes probe and jig capacitance.

Figure 20. Charge Injection (Q_C)



- (1) C_L includes probe and jig capacitance.

Figure 21. Total Harmonic Distortion (THD)

REVISION HISTORY

Changes from Revision B (April 2006) to Revision C	Page
<ul style="list-style-type: none"> Updated package options information. 	2

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TS5A1066DBVR	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 85	(JADF, JADJ, JADR)
TS5A1066DBVR.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	(JADF, JADJ, JADR)
TS5A1066DBVRG4	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	JADF
TS5A1066DBVRG4.B	Active	Production	SOT-23 (DBV) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	JADF
TS5A1066DCKR	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU SN NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JD5, JDF, JDJ, JD R)
TS5A1066DCKR.B	Active	Production	SC70 (DCK) 5	3000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	(JD5, JDF, JDJ, JD R)
TS5A1066YZPR	Active	Production	DSBGA (YZP) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	JDN
TS5A1066YZPR.B	Active	Production	DSBGA (YZP) 5	3000 LARGE T&R	Yes	SNAGCU	Level-1-260C-UNLIM	-40 to 85	JDN

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TS5A1066DBVR	SOT-23	DBV	5	3000	178.0	9.0	3.3	3.2	1.4	4.0	8.0	Q3
TS5A1066DBVRG4	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
TS5A1066DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TS5A1066YZPR	DSBGA	YZP	5	3000	178.0	9.2	1.02	1.52	0.63	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A1066DBVR	SOT-23	DBV	5	3000	180.0	180.0	18.0
TS5A1066DBVRG4	SOT-23	DBV	5	3000	180.0	180.0	18.0
TS5A1066DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TS5A1066YZPR	DSBGA	YZP	5	3000	220.0	220.0	35.0

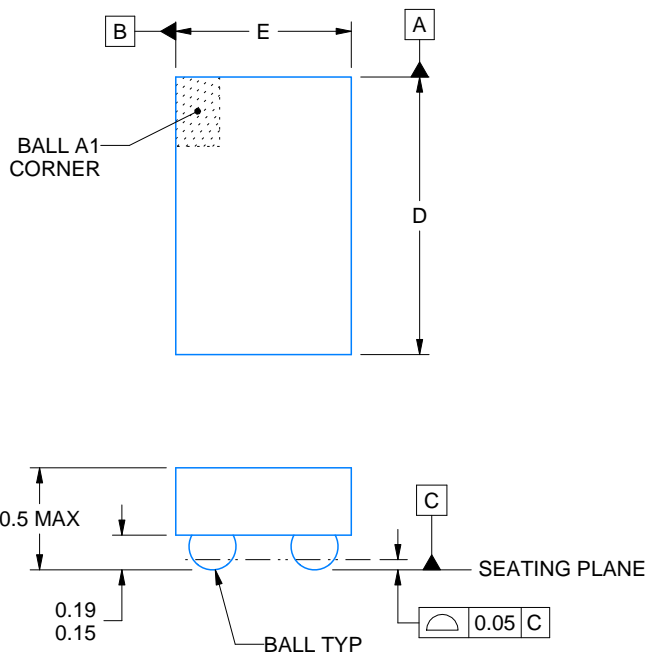
YZP0005



PACKAGE OUTLINE

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



D: Max = 1.418 mm, Min = 1.358 mm

E: Max = 0.918 mm, Min = 0.858 mm

4219492/A 05/2017

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY



LAND PATTERN EXAMPLE
SCALE:40X



SOLDER MASK DETAILS
NOT TO SCALE

4219492/A 05/2017

NOTES: (continued)

3. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).

EXAMPLE STENCIL DESIGN

YZP0005

DSBGA - 0.5 mm max height

DIE SIZE BALL GRID ARRAY

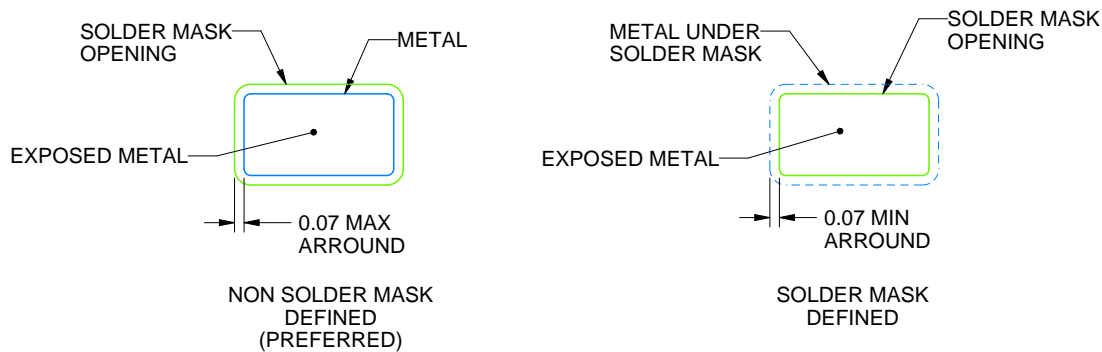
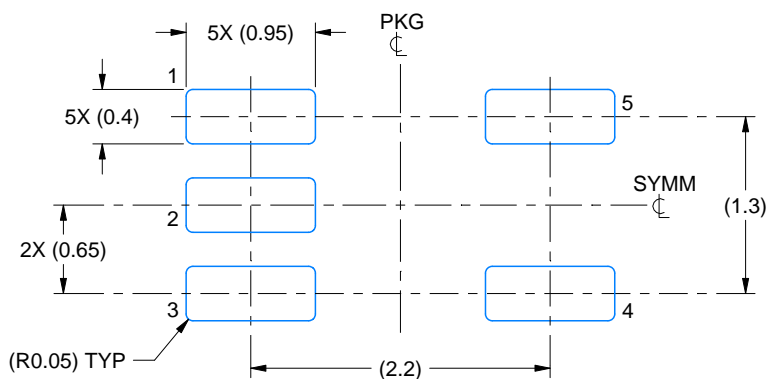


SOLDER PASTE EXAMPLE
BASED ON 0.1 mm THICK STENCIL
SCALE:40X

4219492/A 05/2017

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



4214834/G 11/2024

NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

DBV0005A**PACKAGE OUTLINE****SOT-23 - 1.45 mm max height**

SMALL OUTLINE TRANSISTOR



4214839/K 08/2024

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-178.
4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
5. Support pin may differ or may not be present.

EXAMPLE BOARD LAYOUT

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:15X



SOLDER MASK DETAILS

4214839/K 08/2024

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:15X

4214839/K 08/2024

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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